



NATIONAL INSTITUTE OF TECHNOLOGY ROURKELA – 769 008

INVITATION FOR BIDS (IFB) NATIONAL COMPETITIVE BIDDING FOR GOODS

Date: 10.08.2016

IFB No. NITR/TQ/NCB/2016/1375

1. The Government of India has received a Credit 4685-IN from the International Development Association and a Loan (Loan IN) from the International Bank for Reconstruction and Development in various currencies towards the cost of TEQIP II project and it is intended that part of the proceeds of this credit will be applied to eligible payments under the contracts for which this Invitation for Bids is issued.

2. The National Institute of Technology, Rourkela now invites sealed bids from eligible bidders for supply of Packages listed below:

| SI. No. | Name | Package No. |
|------------|--|-------------|
| i | TEM Laboratory | 194 |
| ii | Low Temperature Engineering Laboratory | 195 |
| iii | Furniture for ten smart classes | 208 |

3. Interested Bidders may obtain further information on purchase of bid documents, time table for issue of bids and submission, cost of bid and methods of payments, technical specification, bid security and pre bid meeting, from the office of the TEQIP II National Institute of Technology, Rourkela, India, or visit the Institute website as per details below:

http://www.nitrkl.ac.in/Jobs_Tenders

Address: Nodal Officer (Procurement), TEQIP- II, National Institute of Technology, Rourkela- 769008, India

Ph:- 0661 - 2462010/2462963/2462529

10.08.2016 Seal of office: National Institute of T Rourkela-7690

Important Dates

| Package Name | Event | Date | Time |
|--|--|------------|-------|
| . TEM Laboratory (Pkg. No. 194) 2. Low Temperature Engineering Laboratory (Pkg. No. 195) 3. Furniture for ten smart classes (Pkg. No. 208) | Date of Commencement of Sale of Bidding Document | 12/08/2016 | 09:00 |
| | Pre-bid Conference | 09/09/2016 | 16:00 |
| | Last Date of submission of Bid | 12/09/2016 | 15:00 |
| | Bid Opening Date | 12/09/2016 | 16:00 |